

# **CD4023BM/CD4023BC** **Buffered Triple 3-Input NAND Gate** **CD4025BM/CD4025BC** **Buffered Triple 3-Input NOR Gate**

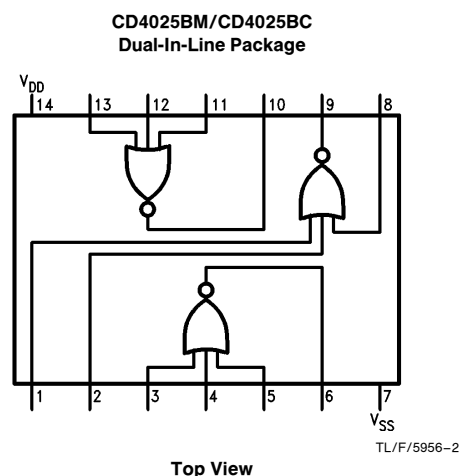
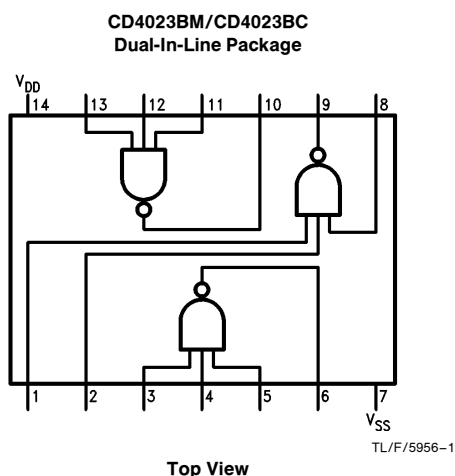
## **General Description**

These triple gates are monolithic complementary MOS (CMOS) integrated circuits constructed with N- and P-channel enhancement mode transistors. They have equal source and sink current capabilities and conform to standard B series output drive. The devices also have buffered outputs which improve transfer characteristics by providing very high gain. All inputs are protected against static discharge with diodes to  $V_{DD}$  and  $V_{SS}$ .

## **Features**

- Wide supply voltage range 3.0V to 15V
- High noise immunity 0.45  $V_{DD}$  (typ.)
- Low power TTL compatibility fan out of 2 driving 74L or 1 driving 74LS
- 5V–10V–15V parametric ratings
- Symmetrical output characteristics
- Maximum input leakage 1  $\mu A$  at 15V over full temperature range

## **Connection Diagrams**



Order Number CD4023B or CD4025B

**CD4023BM/CD4023BC Buffered Triple 3-Input NAND Gate**  
**CD4025BM/CD4025BC Buffered Triple 3-Input NOR Gate**

## Absolute Maximum Ratings (Notes 1 & 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

DC Supply Voltage ( $V_{DD}$ )  $-0.5 V_{DC}$  to  $+18 V_{DC}$

Input Voltage ( $V_{IN}$ )  $-0.5 V_{DC}$  to  $V_{DD} + 0.5 V_{DC}$

Storage Temp. Range ( $T_S$ )  $-65^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$

Power Dissipation ( $P_D$ )

Dual-In-Line 700 mW

Small Outline 500 mW

Lead Temperature ( $T_L$ )

(Soldering, 10 seconds)  $260^{\circ}\text{C}$

## Recommended Operating Conditions

DC Supply Voltage ( $V_{DD}$ )

$5 V_{DC}$  to  $15 V_{DC}$

Input Voltage ( $V_{IN}$ )

$0 V_{DC}$  to  $V_{DD} V_{DC}$

Operating Temperature Range ( $T_A$ )

CD4023BM, CD4025BM

$-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$

CD4023BC, CD4025BC

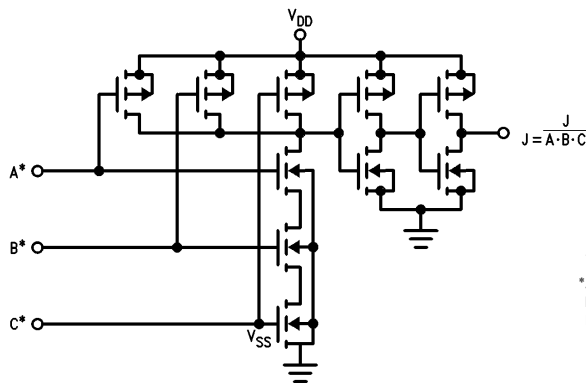
$-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$

## DC Electrical Characteristics CD4023BM, CD4025BM (Note 2)

Symbol	Parameter	Conditions	$-55^{\circ}\text{C}$		$+25^{\circ}\text{C}$			$+125^{\circ}\text{C}$		Units
			Min	Typ	Min	Typ	Max	Min	Max	
$I_{DD}$	Quiescent Device Current	$V_{DD} = 5\text{V}$		0.25		0.004	0.25		7.5	$\mu\text{A}$
		$V_{DD} = 10\text{V}$		0.5		0.005	0.5		15	$\mu\text{A}$
		$V_{DD} = 15\text{V}$		1.0		0.006	1.0		30	$\mu\text{A}$
$V_{OL}$	Low Level Output Voltage	$V_{DD} = 5\text{V}$		0.05		0	0.05		0.05	V
		$V_{DD} = 10\text{V}$		0.05		0	0.05		0.05	V
		$V_{DD} = 15\text{V}$		0.05		0	0.05		0.05	V
$V_{OH}$	High Level Output Voltage	$V_{DD} = 5\text{V}$	4.95		4.95	5		4.95		V
		$V_{DD} = 10\text{V}$	9.95		9.95	10		9.95		V
		$V_{DD} = 15\text{V}$	14.95		14.95	15		14.95		V
$V_{IL}$	Low Level Input Voltage	$V_{DD} = 5\text{V}, V_O = 4.5\text{V}$		1.5		2	1.5		1.5	V
		$V_{DD} = 10\text{V}, V_O = 9.0\text{V}$		3.0		4	3.0		3.0	V
		$V_{DD} = 15\text{V}, V_O = 13.5\text{V}$		4.0		6	4.0		4.0	V
$V_{IH}$	High Level Input Voltage	$V_{DD} = 5\text{V}, V_O = 0.5\text{V}$	3.5		3.5	3		3.5		V
		$V_{DD} = 10\text{V}, V_O = 1.0\text{V}$	7.0		7.0	6		7.0		V
		$V_{DD} = 15\text{V}, V_O = 1.5\text{V}$	11.0		11.0	9		11.0		V
$I_{OL}$	Low Level Output Current (Note 3)	$V_{DD} = 5\text{V}, V_O = 0.4\text{V}$	0.64		0.51	0.88		0.36		mA
		$V_{DD} = 10\text{V}, V_O = 0.5\text{V}$	1.6		1.3	2.2		0.90		mA
		$V_{DD} = 15\text{V}, V_O = 1.5\text{V}$	4.2		3.4	8		2.4		mA
$I_{OH}$	High Level Output Current (Note 3)	$V_{DD} = 5\text{V}, V_O = 4.6\text{V}$	-0.64		-0.51	-0.88		-0.36		mA
		$V_{DD} = 10\text{V}, V_O = 9.5\text{V}$	-1.6		-1.3	-2.2		-0.90		mA
		$V_{DD} = 15\text{V}, V_O = 13.5\text{V}$	-4.2		-3.4	-8		-2.4		mA
$I_{IN}$	Input Current	$V_{DD} = 15\text{V}, V_{IN} = 0\text{V}$		-0.10		$-10^{-5}$	-0.10		-1.0	$\mu\text{A}$
		$V_{DD} = 15\text{V}, V_{IN} = 15\text{V}$		0.10		$10^{-5}$	0.10		1.0	$\mu\text{A}$

## Schematic Diagram

CD4023BC/CD4023BM



$\frac{1}{3}$  Device Shown

\*All Inputs Protected  
by Standard CMOS Input  
Protection Circuit.

TL/F/5956-3

## DC Electrical Characteristics CD4023BC, CD4025BC (Note 2)

Symbol	Parameter	Conditions	−40°C		+25°C			+85°C		Units
			Min	Typ	Min	Typ	Max	Min	Max	
$I_{DD}$	Quiescent Device Current	$V_{DD} = 5V$ $V_{DD} = 10V$ $V_{DD} = 15V$		1.0 2.0 4.0		0.004 0.005 0.006	1.0 2.0 4.0		7.5 15 30	$\mu A$
$V_{OL}$	Low Level Output Voltage	$V_{DD} = 5V$ $V_{DD} = 10V$ $V_{DD} = 15V$		0.05 0.05 0.05		0 0 0	0.05 0.05 0.05		0.05 0.05 0.05	V
$V_{OH}$	High Level Output Voltage	$V_{DD} = 5V$ $V_{DD} = 10V$ $V_{DD} = 15V$	4.95 9.95 14.95		4.95 9.95 14.95	5 10 15		4.95 9.95 14.95		V
$V_{IL}$	Low Level Input Voltage	$V_{DD} = 5V, V_O = 4.5V$ $V_{DD} = 10V, V_O = 9.0V$ $V_{DD} = 15V, V_O = 13.5V$ } $ I_O  < 1\mu A$		1.5 3.0 4.0		2 4 6	1.5 3.0 4.0		1.5 3.0 4.0	V
$V_{IH}$	High Level Input Voltage	$V_{DD} = 5V, V_O = 0.5V$ $V_{DD} = 10V, V_O = 1.0V$ $V_{DD} = 15V, V_O = 1.5V$ } $ I_O  < 1\mu A$	3.5 7.0 11.0		3.5 7.0 11.0	3 6 9		3.5 7.0 11.0		V
$I_{OL}$	Low Level Output Current (Note 3)	$V_{DD} = 5V, V_O = 0.4V$ $V_{DD} = 10V, V_O = 0.5V$ $V_{DD} = 15V, V_O = 1.5V$	0.52 1.3 3.6		0.44 1.1 3.0	0.88 2.2 8		0.36 0.90 2.4		mA
$I_{OH}$	High Level Output Current (Note 3)	$V_{DD} = 5V, V_O = 4.6V$ $V_{DD} = 10V, V_O = 9.5V$ $V_{DD} = 15V, V_O = 13.5V$	−0.52 −1.3 −3.6		−0.44 −1.1 −3.0	−0.88 −2.2 −8		−0.36 −0.90 −2.4		mA
$I_{IN}$	Input Current	$V_{DD} = 15V, V_{IN} = 0V$ $V_{DD} = 15V, V_{IN} = 15V$		−0.3 0.3		$-10^{-5}$ $10^{-5}$	−0.3 0.3		−1.0 1.0	$\mu A$

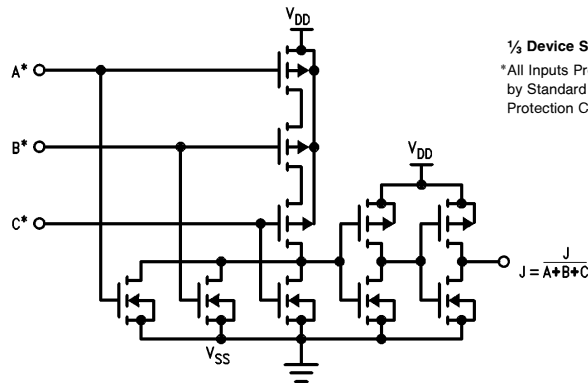
**Note 1:** "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed; they are not meant to imply that the devices should be operated at these limits. The table of "Recommended Operating Conditions" and "Electrical Characteristics" provides conditions for actual device operation.

**Note 2:**  $V_{SS} = 0V$  unless otherwise specified.

**Note 3:**  $I_{OH}$  and  $I_{OL}$  are tested one output at a time.

## Schematic Diagram

CD4025BM/CD4025BC



TL/F/5956-4

# AC Electrical Characteristics\* $T_A = 25^\circ\text{C}$ , $C_L = 50\text{ pF}$ , $R_L = 200\text{ k}$ , unless otherwise specified

Symbol	Parameter	Conditions	CD4023BC CD4023BM			CD4025BC CD4025BM			Units
			Min	Typ	Max	Min	Typ	Max	
$t_{\text{PHL}}$	Propagation Delay, High-to-Low Level	$V_{\text{DD}} = 5\text{V}$		130	250		130	250	ns
		$V_{\text{DD}} = 10\text{V}$		60	100		60	100	ns
		$V_{\text{DD}} = 15\text{V}$		40	70		40	70	ns
$t_{\text{PLH}}$	Propagation Delay, Low-to-High Level	$V_{\text{DD}} = 5\text{V}$		110	250		120	250	ns
		$V_{\text{DD}} = 10\text{V}$		50	100		60	100	ns
		$V_{\text{DD}} = 15\text{V}$		35	70		40	70	ns
$t_{\text{THL}}$ , $t_{\text{TLH}}$	Transition Time	$V_{\text{DD}} = 5\text{V}$		90	200		90	200	ns
		$V_{\text{DD}} = 10\text{V}$		50	100		50	100	ns
		$V_{\text{DD}} = 15\text{V}$		40	80		40	80	ns
$C_{\text{IN}}$	Average Input Capacitance	Any Input		5	7.5		5	7.5	pF
$C_{\text{PD}}$	Power Dissipation Capacity (Note 4)	Any Gate		17			17		pF

\*AC Parameters are guaranteed by DC correlated testing.

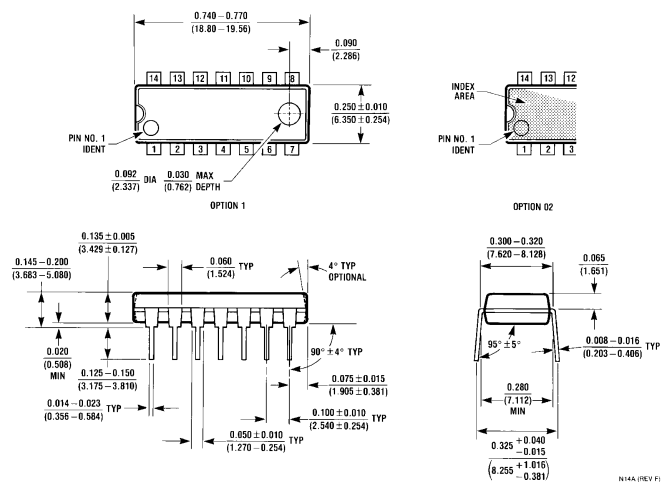
**Note 4:**  $C_{\text{PD}}$  determines the no load AC power consumption of any CMOS device. For complete explanation, see 54C/74C Family Characteristics Application Note AN-90.

The drawing shows a 14-pin DIP package. The top view indicates a width of 0.785 (19.939 MAX) and a height of 0.220-0.310 (5.588-7.874). The pins are numbered 1-14. A fillet radius of 0.025 (0.635) RAD is shown at the corner. The side view shows a package height of 0.005 (0.127) MIN, a glass sealant thickness of 0.060 ± 0.005 (1.524 ± 0.127), and a pin pitch of 0.100 ± 0.010 (2.540 ± 0.254). The pin diameter is 0.018 ± 0.003 (0.457 ± 0.076). The package width is 0.200 (5.080) MAX. The pin length is 0.125-0.200 (3.175-5.080). The package thickness is 0.020-0.060 (0.508-1.524). The package is marked with 86°/94° TYP. The drawing is labeled J14A (REV G).

J14A (REV G)

CD4023BM/CD4023BC Buffered Triple 3-Input NAND Gate  
CD4025BM/CD4025BC Buffered Triple 3-Input NOR Gate

Physical Dimensions inches (millimeters) (Continued)



Molded Dual-In-Line Package (N)  
Order Number CD4023BMN, CD4023BCN, CD4025BMN or CD4025BCN  
NS Package Number N14A

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